

PATENT
83371.0002
Express Mail Label No. EL 894 838 027 US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Hideo SHINOZAWA et al.

Serial No: Not assigned

Filed: November 15, 2001

For: SEMICONDUCTOR LASER, METHOD FOR
FABRICATING THEREOF, AND METHOD FOR
MOUNTING THEREOF

Art Unit: Not assigned

Examiner: Not assigned

jc997 U.S. PTO
09/990671
11/15/01



**TRANSMITTAL OF INFORMATION DISCLOSURE
STATEMENT**

Box PATENT APPLICATION
Assistant Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

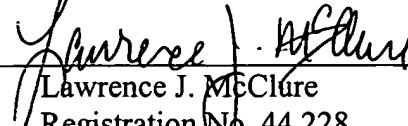
The information disclosure statement submitted herewith is being filed concurrently with the subject application [37 C.F.R. § 1.97(b)] and contains no items of information cited in any communication from a foreign patent office in a counterpart foreign application [37 C.F.R. § 1.97(e)(1)].

If it should be determined that for any reason either an insufficient or excessive fee has been paid, please charge any insufficiency or credit any overpayment necessary to ensure consideration of the information disclosure statement for the above-identified application to Deposit Account No. 50-1314. A copy of this paper is enclosed.

Respectfully submitted,

HOGAN & HARTSON L.L.P.

Date: November 15, 2001

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